

DISCUSSION OF THE AMENDMENT

Due to the length of the specification herein, Applicants will cite to the paragraph number of the published patent application (PG Pub) of the present application, i.e., US 2005/0260405, when discussing the application description, both in this section and in the Remarks section, *infra*, rather than to page and line of the specification as filed.

Claim 1 has been amended by deleting all subject matter with regard to a second substrate, and by inserting a Markush group for the substrate, as supported in the specification at paragraph [0025]. Claims 3 and 4 have been canceled.

New Claim 27 has been added, as supported by the embodiment of original Claim 2 wherein coat (C) is present and acts as a second substrate, together with Claim 1 (“a polymer film”) prior to the above-discussed amendment.

Claims 16 and 26 have been amended to depend on Claim 27. Claim 16 has been additionally amended by deleting superfluous matter.

New Claim 28 has been added, as supported by original Claim 1, together with Claim 6.

No new matter is believed to have been added by the above amendment. Claims 1, 5-9, 16, and 19-28 are now pending in the application. All claims are active except Claim 25, which stands withdrawn from consideration.

REMARKS

The rejection of Claims 1-9 and 16-24 under 35 U.S.C. § 103(a) as unpatentable over US 6,500,883 (Mack et al) in view of US 6,482,489 (Otaki et al), and US 3,880,953 (Downey) or US 4,136,071 (Korpman), is respectfully traversed.

Mack et al is drawn to improving the impact resistance of filled polyamides by adding a component having adhesion-promoting properties (column 3, line 43ff). Mack et al neither discloses nor suggests any of the substrate materials recited in above-amended Claim 1. Otaki et al is drawn to hologram laminates wherein pressure-sensitive adhesives are used. Downey and Korpman are relied on for a disclosure of thermoplastic elastomers as pressure sensitive adhesives. However, neither Otaki et al, Downey nor Korpman disclose a layer of a polyacrylate or poly-*iso*-butene, as required by Claim 28. Thus, even if Otaki et al, Downey and Korpman were combined with Mack et al, the result would not be the invention of any of the presently-active claims. Accordingly, it is respectfully requested that this rejection be withdrawn.

The rejection of Claims 1-9 and 16-24 under 35 U.S.C. § 103(a) as unpatentable over US 6,103,370 (Onozawa et al) in view of JP 05-18671 (Matsuoka et al), and Downey or Korpman, is respectfully traversed.

Onozawa et al is drawn to a hard coat sheet comprising a base sheet and a coat layer, which is disclosed as adherable to, for example, a window pane by providing an adhesive layer on the back of the base sheet. Matsuoka et al is relied on for a disclosure of a windshield plate made of a polycarbonate resin. Downey and Korpman have been discussed above. The Examiner's rationale is that it would have been obvious to employ the polycarbonate of Matsuoka et al as the window pane material of Onozawa et al, and to employ the pressure sensitive adhesives of Downey or Korpman to adhere the base sheet of Onozawa et al to a polycarbonate window pane. However, none of the applied prior art

discloses or suggests any of the substrate materials recited in above-amended Claim 1, or the polyacrylates or polyisobutenes of Claim 28. Accordingly, it is respectfully requested that this rejection be withdrawn.

The rejection of Claims 1-7, 9, 17-19 and 21-24 under 35 U.S.C. § 103(a) as unpatentable over US 2003/0104245 (Bergh et al) in view of US 5,334,842 (Van Havenbergh et al), is respectfully traversed.

The Examiner relies on Bergh et al as disclosing all the recited layers of the rejected claims except the substrate. The Examiner relies on Van Havenbergh et al for a disclosure of particular supports as meeting the substrate limitation of the present claims. The Examiner particularly relies on the material LUMIRROR C (column 17, line 52ff), which the Examiner finds is a polyethylene. However, according to Van Havenbergh et al, LUMIRROR C appears to be not a polyethylene, but polyethylene terephthalate. Nevertheless, Van Havenbergh et al neither discloses nor suggests any of the substrate materials recited in above-amended Claim 1, nor does either reference disclose or suggest the presently-recited polyacrylates or polyisobutenes of Claim 28. Accordingly, it is respectfully requested that this rejection be withdrawn.

The rejection of Claims 1, 3-9, 16, 19-24 and 26 under 35 U.S.C. § 112, second paragraph, as indefinite, is respectfully traversed. Indeed, the rejection would now appear to be moot in view of the above-discussed amendment. Accordingly, it is respectfully requested that the rejection be withdrawn.

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Reply to Office Action of December 10, 2009

Applicants respectfully submit that all of the presently-pending claims in this application are now in immediate condition for allowance. Accordingly, the Examiner is respectfully requested to pass this application to issue.

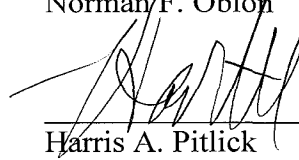
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Respectfully submitted,

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A handwritten signature in black ink, appearing to read "H. Pitlick", is written over a horizontal line.

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